



DEFENSE LOGISTICS AGENCY
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PLY
 R TO DSCC-VQ (VQE-06-011451/Mr. Jeffrey Ciesla/614-692-0624/jpc)

JUL 20 2006

SUBJECT: Notification of Qualification, MIL-PRF-31032, CAGE Code: 66030

Mr. Tom Tikusis
 Electrotek Corporation
 7745 S. 10th Street
 Oak Creek, WI 53154

Dear Mr. Tikusis:

Qualification of your products is granted under the current issue of the specification as a result of successful qualification testing to Military Performance Specification MIL-PRF-31032, Printed Circuit Board/Printed Wiring Board, and associated specification MIL-PRF-31032/1. The material and classification indicated below shall be listed on Qualified Manufacturers List QML-31032. Additionally, qualification is granted to QPL-55110 per paragraph 6.3.4 of MIL-PRF-31032 and MIL-PRF-55110 Appendix B. The effective date of this qualification is July 19, 2006.

MANUFACTURER NAME & ADDRESS Electrotek Corporation 7745 S. 10 th Street Oak Creek, WI 53154	BASIC PLANT LOCATION SAME	CAGE CODE: 66030 Contact: Tom Tikusis, Don Dawson PHONE #: 414-762-1390 FAX #: 414-762-1510 EMAIL: sales@boards4u.com
CAPABILITIES BY TECHNOLOGY / PRINTED BOARD TYPE:		QUALIFICATION LETTERS:
MIL-PRF-31032 /1 Max. Panel Size 18" X 24" Max. Board Thickness 0.115" Min. Drilled Thru Hole Size 0.012" Aspect Ratio 9:1 Number of Layers 18 Min. Conductor Width 0.003" Min. Conductor Spacing 0.003" Part Mounting SM, TH, MIX Base Materials GF (Woven E-Glass, Epoxy resin) GI (Woven E-Glass, Polyimide resin) Finish Systems Hot Air Solder Level (HASL) ENIG Immersion Gold Hole Preparation Plasma/Permanganate Desmear/Etchback Copper Plating Electroplated Acid Copper Solder Resist Liquid Photoimageable (LPI), Dryfilm Controlled Impedance GF – 100Ω / 50Ω ± 10% GI – 100Ω ± 10%		VQ-06-011451 (Initial Qual)

This qualification is based on your MIL-PRF-31032 certification and is subject to the conditions stated below:

1. A listing on the Qualified Manufacturers List (QML) does not guarantee acceptance of the product(s) in any future purchase.
2. QML listing does not constitute a waiver of any requirements of the specification or of the provisions of any contract.
3. Advertising of qualification information is permitted. Permission to use such information for advertising or publicity purposes is granted provided that such publicity or advertising does not state or imply that the product(s) is the only product of that type qualified or that the Department of Defense in any way recommends or endorses the manufacturer's product.
4. The listing applies only to products produced in the plant(s) specified in this letter of notification of qualification and applies to future amendments or revisions of the specification, unless otherwise notified.
5. The listing applies only to materials and manufacturing construction techniques identical to or covered by that (those) qualified. The qualifying activity must be advised in advance of any change to the materials and manufacturing construction techniques. Failure to notify the qualifying activity of any change to the materials and manufacturing construction techniques is cause for removal from the QML.

Because we are held responsible for the accuracy and currency of this QML, please inform us if your company discontinues production utilizing these materials or processes. If you have any questions, please contact Mr. Jeffrey P. Ciesla at vqe.jc@dla.mil or (614) 692-0624.

Sincerely,



ROBERT P. EVANS
Chief
Sourcing and Qualification Unit